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# AS1363 500mA, Low-Dropout Linear Voltage Regulator

# **1** General Description

The AS1363 is a low-dropout linear regulator that operates from a +2.0 to +5.5V supply and delivers a guaranteed 500mA load current with low 150mV dropout.

The device is available in two versions (see Table 1). One version has a high-accuracy output with a preset voltage (1.2, 1.5, 1.8, 3.0, 3.3, or 4.5V). This voltage is internally trimmed and also offers a Bypass pin. With a capacitor connected to this Bypass pin, the PSRR and the Noise performance is improved.

At the other version the output voltage is user-adjustable (1.2V to 5.3V) and offers an SET pin for setting the output voltage.

Table 1. Standard Products

| Model     | Output Type | BYP | SET |
|-----------|-------------|-----|-----|
| AS1363-AD | Adjustable  | No  | Yes |
| AS1363    | Fixed       | Yes | No  |

A low supply current (65µA typ.) at maximum load is making the device ideal for portable battery-operated equipment.

Other features are included such as an active-low opendrain reset output that indicates when the output is out of regulation, a low-current (30nA typ.) shutdown mode, an integrated short-circuit and a thermal shutdown protection.

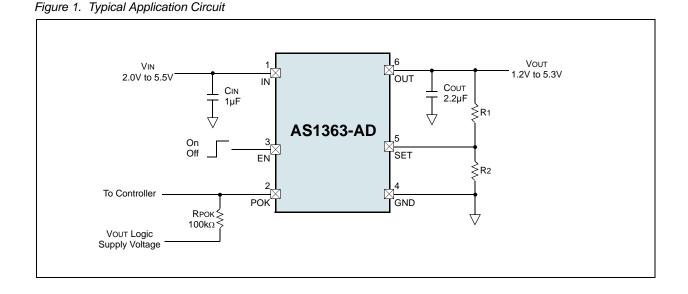
The AS1363 is available in a 6-pin SOT23 package.

2 Key Features

- Guaranteed Output Current: 500mA
- Low Dropout: 150mV @ 500mA
- 2.0V to 5.5V Input Voltage
- Fixed Output Voltage: 1.2V to 5.0V
- User-Adjustable Output Voltage: 1.2V to 5.3V
- Power OK Output
- Low Quiescent Current: 40µA
- Low Shutdown Current: 30nA
- Thermal Overload Protection
- Output Current Limit
- 6-pin SOT23 Package

# **3** Applications

The device is ideal for laptops, PDAs, portable audio devices, mobile phones, cordless phones, and any other battery-operated portable device.



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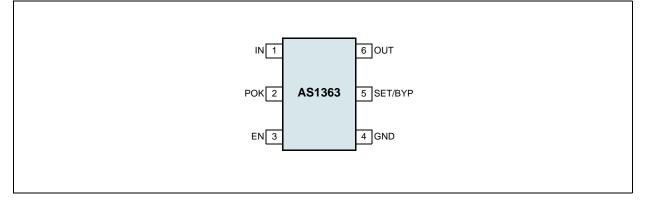
#### **Data Sheet**



# 4 Pinout

## **Pin Assignments**

Figure 2. Pin Assignments (Top View)



# **Pin Descriptions**

Table 2. Pin Descriptions

| Pin Number | Pin Name | Description  |
|------------|----------|--|
| 1          | IN       | +2.0V to +5.5V Supply Voltage. Bypass this pin with a 1µF capacitor to GND (see Capacitor Selection and Regulator Stability on page 11).   |
| 2          | POK      | <b>Open-Drain POK Output</b> . POK remains low while VOUT is below the POK threshold. Connect a $100k\Omega$ pull-up resistor from this pin to OUT to obtain an output voltage (see Figure 1 on page 1). |
| 3          | EN       | Active-High Enable Input. A logic low reduces supply current below 30nA. In shutdown mode, the POK output is low, and OUT is high impedance. Connect this pin to IN for normal operation.                |
| 4          | GND      | Ground   |
| 5          | SET      | <b>Voltage-Setting Input</b> . Connect to GND for preset output or Connect to a resistive voltage-divider between OUT and GND to set the output voltage between 1.2V and 5.3V (see Figure 1 on page 1).  |
|            | BYP      | <b>Bypass Pin.</b> Connect a 10nF capacitor from this pin to VOUT to improve PSRR and noise performance (see Figure 16 on page 9).   |
| 6          | OUT      | Output.Sources up to 500mA. Bypass this pin with a 2.2μF low-ESR capacitor toGND (see Figure 1 on page 1).Note:For output voltages below 2V a 4.7μF capacitor should be used.                            |

# **5** Absolute Maximum Ratings

Stresses beyond those listed in Table 3 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Electrical Characteristics on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

| Parameter                     | Min  | Max      | Units | Comments   |
|-------------------------------|------|----------|-------|--|
| IN, POK, EN, SET/BYP to GND   | -0.3 | +6       | V     |  |
| OUT to GND                    | -0.3 | VIN +0.3 | V     |  |
| Output Short-Circuit Duration |      | 1        | min   |  |
| Continuous Power Dissipation  |      | 800      | mW    | TAMB = +70°C; derate 10mW/°C above +70°C   |
| Operating Temperature Range   | -40  | +85      | °C    |  |
| Storage Temperature Range     | -65  | +150     | °C    |  |
| Junction Temperature          |      | +150     | °C    |  |
| Package Body Temperature      |      | +260     | ٥C    | The reflow peak soldering temperature (body<br>temperature) specified is in accordance with<br>IPC/JEDEC J-STD-020C "Moisture/Reflow<br>Sensitivity Classification for Non-Hermetic Solid<br>State Surface Mount Devices".<br>The lead finish for Pb-free leaded packages is<br>matte tin (100% Sn). |

Table 3. Absolute Maximum Ratings

# **6 Electrical Characteristics**

 $V_{IN} = V_{OUT(NOM)} + 500mV$  or  $V_{IN} = +2.0V$  (whichever is greater),  $C_{IN} = 1\mu$ F,  $C_{OUT} = 2.2\mu$ F, EN = IN,  $T_{AMB} = -40$  to +85°C (unless otherwise specified). Typical values are at  $T_{AMB} = +25$ °C.

| Symbol        | Parameter                                      | Condition  |        | Тур  | Max    | Unit  |
|---------------|--|--|--------|------|--------|-------|
| Vin           | Input Voltage                                  |  | 2.0    |      | 5.5    | V     |
| VPOR          | Power On reset                                 | Falling, 100mV hysteresis                          |        | 1.87 | 1.96   | V     |
|               |  | IOUT = 100mA, Тамв = +25°С,                        | -0.75  |      | +0.75  |       |
|               | Output Voltage Accuracy<br>(Preset Mode)       | IOUT = 100mA                                       | -1.5   |      | +1.5   | %     |
|               | (Treset Mode)                                  | IOUT = 1 to 500mA, VIN > $(VOUT + 0.5V)^{1}$       | -2     |      | +2     |       |
| Vout          | Adjustable Output Voltage<br>Range             |  | 1.2    |      | 5.3    | V     |
| VSET/BYP      | SET/BYP Voltage Threshold<br>(Adjustable Mode) | VIN = 2.5V, IOUT = 100mA,<br>Vout set to 2.0V      | 1.17   | 1.20 | 1.23   | V     |
| Ιουτ          | Guaranteed Output Current<br>(RMS)             |  | 500    |      |        | mA    |
| ILIMIT        | Short-Circuit Current Limit                    | Vout = 0V  | 0.55   | 0.8  | 1.2    | А     |
|               | In-Regulation Current Limit                    | VOUT > 96% of nominal value                        |        | 0.8  |        | А     |
|               | SET/BYP Threshold                              |  | 50     | 100  | 150    | mV    |
| ISET          | SET/BYP Input Bias Current                     | VSET/BYP = 1.2V                                    | -100   |      | +100   | nA    |
| lq            | Quiescent Current                              | Ιουτ = 100μΑ                                       |        | 40   | 150    | μA    |
| IQ            | Quiescent Current                              | IOUT = 500mA                                       |        | 65   | 200    |       |
| Vin -<br>Vout | Dropout Voltage <sup>2</sup>                   | IOUT = 500mA VOUT = 2.5V                           |        | 150  | 320    | mV    |
| $\Delta VLNR$ | Line Regulation                                | VIN from (VOUT + 100mV) to 5.5V,<br>ILOAD = 5mA    | -0.125 |      | +0.125 | %/V   |
| $\Delta VLDR$ | Load Regulation                                | IOUT = 1 to 500mA                                  |        |      | +0.001 | %/mA  |
|               |  | f = 1kHz, IOUT = 10mA, adjustable Output           |        | 65   |        | dB    |
| PSRR          | Ripple Rejection                               | f = 10kHz, Iou⊤ = 10mA, adjustable<br>Output       |        | 70   |        |       |
|               |  | f = 100kHz, Iout = 10mA, adjustable<br>Output      |        | 60   |        |       |
|               |  | 10Hz to 100kHz, lou⊤ = 10mA, adjustable<br>Output  |        | 80   |        |       |
|               | Output Voltage Noise                           | 100Hz to 100kHz, lou⊤ = 10mA,<br>adjustable Output |        | 65   |        | µVrмs |
| Shutdown      |  |  |        |      |        |       |
| IOFF          | Shutdown Supply Current                        | $EN = GND$ , $VIN = 5.5V$ , $TAMB = 25^{\circ}C$   |        | 0.03 | 0.5    | μA    |
| 1011          | Shuldown Supply Current                        | EN = GND, $VIN = 5.5V$                             |        |      | 15     | μΑ    |
| Vih           | EN Input Threshold                             | 2.0V < VIN < 5.5V                                  | 1.6    |      |        | V     |
| VIL           |  | 2.0V < VIN < 5.5V                                  |        |      | 0.6    | V     |
| len           |  | EN = IN or GND, TAMB = +25°C                       |        | 1    |        | r ^   |
| IEN           | EN Input Bias Current                          | TAMB = +85°C                                       |        | 5    |        | nA    |
| POK Outp      | out  |  |        |      |        |       |

| Symbol           | Parameter                                       | Condition                             | Min | Тур  | Max  | Unit |
|------------------|---|---------------------------------------|-----|------|------|------|
| Vol              | POK Output Low Voltage                          | POK sinking 1mA                       |     | 0.05 | 0.25 | V    |
|                  | Operating Voltage Range for<br>Valid POK Signal | POK sinking 100µA                     |     |      | 5.5  | V    |
|                  | POK Output High leakage                         | POK = 5.5V, TAMB = +25°C              |     | 1    |      | ~^   |
|                  | Current   | Тамв = +85°С                          | 5   |      | nA   |      |
|                  | POK Threshold                                   | Rising edge (referenced to VOUT(NOM)) |     | 94   | 98   | %    |
| Thermal F        | Protection                                      |                                       |     |      |      |      |
| TSHDNN           | Thermal Shutdown<br>Temperature                 |                                       |     | 170  |      | °C   |
| $\Delta T$ SHDNN | Thermal Shutdown Hysteresis                     |                                       |     | 20   |      | °C   |

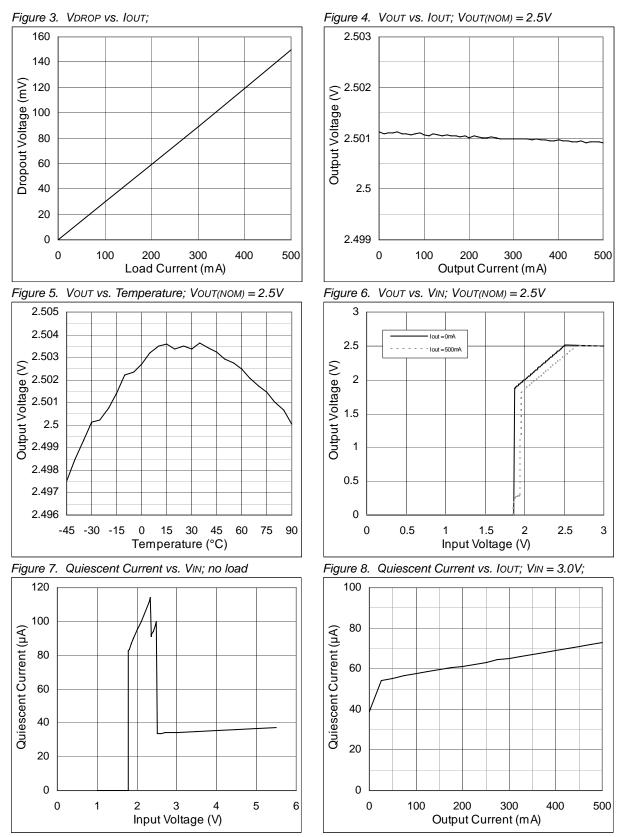
#### Table 4. Electrical Characteristics (Continued)

1. Guaranteed by production test of load regulation and line regulation.

2. Dropout voltage is defined as VIN - VOUT, when VOUT is 100mV below the value of VOUT measured for VIN = (VOUT(NOM) + 500mV). Since the minimum input voltage is 2.0V, this specification is only valid when VOUT(NOM) > 2.0V.

# **7** Typical Operating Characteristics

VIN = VOUT(NOM) + 0.5V,  $CIN = 1\mu F$ ,  $COUT = 2.2\mu F$ , TAMB = 25°C (unless otherwise specified).



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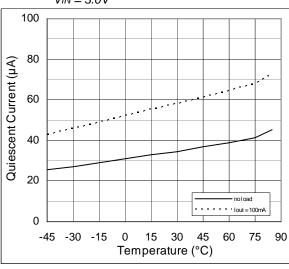
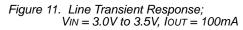
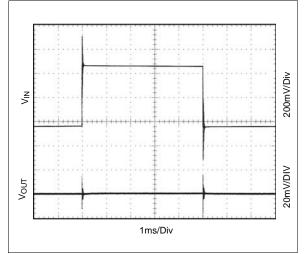
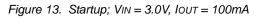
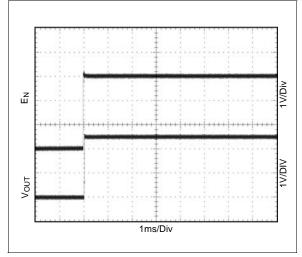


Figure 9. Quiescent Current vs. Temperature;  $V_{IN} = 3.0V$ 









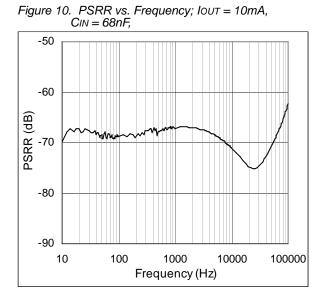


Figure 12. Load Transient Response;  $V_{IN} = 3.0V$ ,  $I_{OUT} = 50mA$  to 250mA

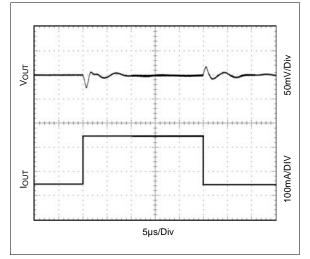
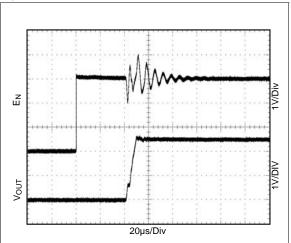


Figure 14. Startup; VIN = 3.0V, IOUT = 100mA



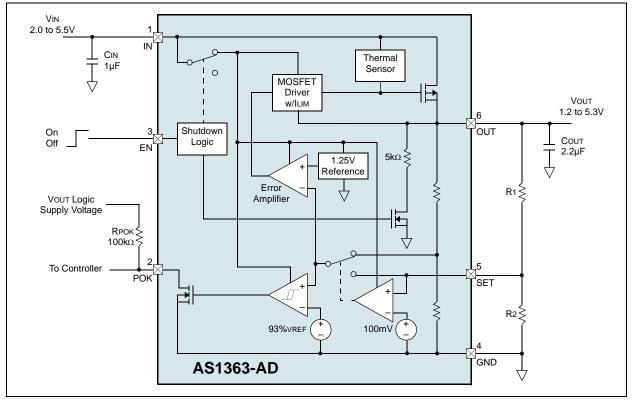
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# 8 Detailed Description

The AS1363 is a low-dropout, low-quiescent-current linear regulator specifically designed for battery-powered devices. The regulator supplies loads of up to 500mA and can deliver a factory-preset output voltage or user-adjustable output voltage.

The device features a 1.2V reference, error amplifier, P-channel pass transistor, and internal feedback voltage-divider (see Figure 15). Additional blocks include an output current limiter, thermal sensor, and shutdown logic.





The 1.2V reference is connected to the error amplifier, which compares this reference with the feedback voltage and amplifies the difference. If the feedback voltage is lower than the reference voltage, the pass-transistor gate is pulled lower, allowing more current to pass to the output and increases the output voltage. If the feedback voltage is too high, the pass transistor gate is pulled up, allowing less current to pass to the output.

The output voltage is delivered back through either an internal resistive divider connected to OUT or an external resistor network connected to SET (see Figure 15). The comparator examines VSET/BYP and selects the feedback path. If VSET/BYP is less than 50mV, the internal feedback path is used and the output is regulated to the factory-preset voltage (see Ordering Information on page 13).

## **Internal P-Channel Pass Transistor**

The AS1363 features a P-channel MOSFET pass transistor and consumes only a maximum of 200µA of quiescent current under heavy loads as well as in dropout.

#### Shutdown

If pin EN is connected to GND the AS1363 is disabled. In shutdown mode all internal circuits are turned off, reducing supply current to 30nA (typ.). For normal operation pin EN must be connected to IN. During shutdown, POK is low.

## **Output Voltage Selection**

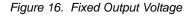
The AS1363 is available in two versions (see Ordering Information on page 13). One version can only operate at one fixed output voltage and the other version can operate with a preset output voltage or with user-adjustable output voltages (1.2V to 5.3V).

- For the fixed output voltage version connect a capacitor CBYP from pin BYP to VOUT to improve PSRR and Noise performance (see Figure 16).
- To use the factory preset output voltage of the user-adjustable output voltage version, connect pin SET to GND (see Figure 17).
- For configurations using an output voltage other than the factory preset, a voltage-divider from OUT to SET to GND is required, as shown in (see Figure 1 on page 1). A value for R<sub>2</sub> in the 25kΩ to 100kΩ range should be sufficient. Calculate the value for R<sub>1</sub> as:

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{V_{SETBYP}} - 1\right)$$
(EQ 1)

Where:

VOUT is in a range from 1.2V to 5.3V. VSET/BYP = 1.2V.



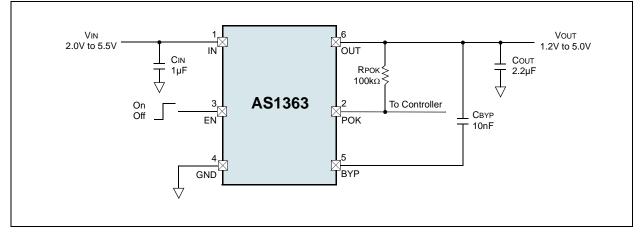
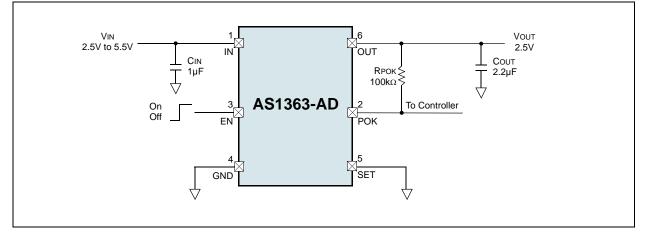


Figure 17. Adjustable Output using preset Output Voltage



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## **Power-OK**

The AS1363 features a power-ok indicator that asserts when the output voltage falls out of regulation. The open-drain POK output goes low when output voltage at OUT falls 6% below its nominal value. A  $100k\Omega$  pull-up resistor from POK to a (typically OUT) provides a logic control signal.

POK can be used as a power-on-reset (POR) signal to a microcontroller or can drive an external LED to indicate a power failure condition.

**Note:** POK is low during shutdown.

### **Current Limit**

The AS1363 features current limiting circuitry that monitors the pass transistor, limiting short-circuit output current to 0.8A (typ). The circuitry of the AS1363 allows that the output can be shorted to ground for an indefinite period of time without damaging the device.

#### **Thermal Overload Protection**

Integrated thermal overload protection limits the total power dissipation in the AS1363. When the junction temperature (TJ) exceeds +170°C typically, the pass transistor is turned off. Normal operation is continued when TJ drops approximately 20°C.

Note: Regardless of the hysteresis, continuous short-circuit condition will result in a pulsed output.

## **Operating Region and Power Dissipation**

Maximum power dissipation depends on the thermal resistance of the IC package and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow.

The power dissipated in the device is given as:

$$PD = I_{OUT} \times (V_{IN} - V_{OUT}) \tag{EQ 2}$$

The AS1363 can deliver up to 0.5A RMS and operates with input voltages up to +5.5V, but not at the same time. High output currents can only be sustained when input/output differential voltages are low.

The maximum allowed power dissipation is 800mW at TAMB = +70°C or:

$$PDMAX = \frac{T_{J(max)} - T_{AMB}}{\theta_{JC} + \theta_{CA}}$$
(EQ 3)

Where:

 $T_{J(MAX)}$  - TAMB is the temperature difference between the device die junction and the surrounding air.  $\theta_{JC}$  is the thermal resistance of the junction to the case.

 $\theta$ CA is the thermal resistance from the case through the PCB, copper traces, and other materials to the surrounding air.

Note: For best heat transfer, the copper area should be equally shared between the IN, OUT, and GND pins.

# **9** Application Information

## **Capacitor Selection and Regulator Stability**

Input and output capacitors are required for stable operation of the AS1363 over the full temperature range and with load currents up to 500mA. Connect CIN and COUT as close to the AS1363 as possible to minimize the impact of PC board trace inductance.

For CIN, connect a  $1\mu$ F capacitor between IN and ground. CIN lowers the source impedance of the input supply. Reduce noise and improve load-transient response, stability, and power supply rejection by using larger output capacitors, such as  $10\mu$ F.

For COUT connect a 2.2 $\mu$ F low-ESR capacitor between OUT and ground. The output capacitor's ESR affects stability and output noise. Use output capacitors with an ESR of 0.1 $\Omega$  or less to ensure stability and optimum transient response. Surface-mount ceramic capacitors have very-low ESR and are commonly available in values up to 10 $\mu$ F.

For output voltages less than 2V, use a 4.7µF low-ESR output capacitor for Cout.

## Noise, Power Supply Rejection Ratio, and Transient Response

The AS1363 is designed to operate with low dropout voltages and low quiescent currents in battery-powered systems while still maintaining good noise response, transient response, and AC rejection. See Typical Operating Characteristics on page 6 for a plot of power-supply rejection ratio (PSRR) versus frequency. When operating from noisy sources, improved supply-noise rejection and transient response can be achieved by increasing the values of the input and output bypass capacitors and through passive filtering techniques.

## **Dropout Voltage**

Because the AS1363 uses a P-channel MOSFET pass transistor, its dropout voltage is a function of drain-to-source on-resistance (RDS(ON)) multiplied by the load current:

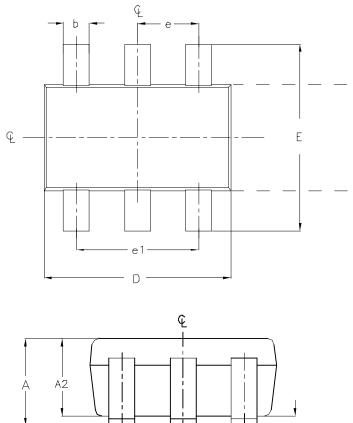
$$V_{DROPOUT} = V_{IN} - V_{OUT} = R_{DS(ON)} \times I_{OUT}$$
(EQ 4)

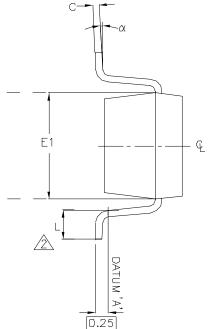
Note: The AS1363 ground current remains below 200µA in dropout.

# **10 Package Drawings and Markings**

The device is available in an 6-pin SOT23 package.

Figure 18. 6-pin SOT23 Package





# A1 □ -A- .10

#### Notes:

- 1. Dimensions are in millimeters (mm).
- 2. Foot length measured at intercept point between datum A and lead surface.
- 3. Package outline exclusive of mold flash and metal burr.
- 4. Package outline inclusive of solder plating.
- 5. Complies with EIAJ SC74A.

| Symbol | Min     | Nom      | Max  |  |  |
|--------|---------|----------|------|--|--|
| A      | 0.90    |          | 1.45 |  |  |
| A1     | 0.00    | 0.00 0.1 |      |  |  |
| A2     | 0.90    |          | 1.30 |  |  |
| b      | 0.30    |          | 0.50 |  |  |
| С      | 0.09    |          | 0.20 |  |  |
| D      | 2.80    |          | 3.05 |  |  |
| E      | 2.60    |          | 3.00 |  |  |
| E1     | 1.50    |          | 1.75 |  |  |
| L      | 0.30    |          | 0.55 |  |  |
| E      | 0.95Ref |          |      |  |  |
| e1     | 1.90Ref |          |      |  |  |
| α      | 0°      |          | 8º   |  |  |

# **11 Ordering Information**

The device is available as the standard products shown in Table 5.

#### Table 5. Ordering Information

| Model           | Marking | Output                         | SET/BYP | Delivery Form | Package     |
|-----------------|---------|--------------------------------|---------|---------------|-------------|
| AS1363-BSTT-AD  | ASQ9    | adjustable<br>(preset to 2.5V) | SET     | Tape and Reel | 6-pin SOT23 |
| AS1363-BSTT-12* | ASRY    | 1.2V                           | BYP     | Tape and Reel | 6-pin SOT23 |
| AS1363-BSTT-15* | ASRA    | 1.5V                           | BYP     | Tape and Reel | 6-pin SOT23 |
| AS1363-BSTT-18* | ASRB    | 1.8V                           | BYP     | Tape and Reel | 6-pin SOT23 |
| AS1363-BSTT-30* | ASRC    | 3.0V                           | BYP     | Tape and Reel | 6-pin SOT23 |
| AS1363-BSTT-33* | ASRD    | 3.3V                           | BYP     | Tape and Reel | 6-pin SOT23 |
| AS1363-BSTT-45* | ASRE    | 4.5V                           | BYP     | Tape and Reel | 6-pin SOT23 |

All devices are RoHS compliant and free of halogene substances.

\*Future product.

Non-standard devices are available between 1.4V and 4.6V in 50mV steps and between 4.6V and 5.0V in 100mV steps. For more information and inquiries contact http://www.austriamicrosystems.com/contact-us



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## **Contact Information**

Headquarters austriamicrosystems AG A-8141 Schloss Premstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

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